Panasonic

2SD2413

Silicon NPN triple diffusion planer type

For low-frequency output amplification

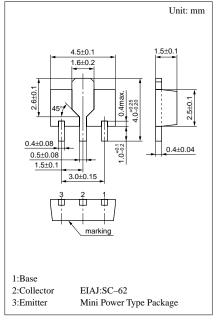
Features

- High collector to base voltage V_{CBO}.
- High collector to emitter voltage V_{CEO}.
- Large collector power dissipation P_C.
- Low collector to emitter saturation voltage V_{CE(sat)}.
- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit	
Collector to base voltage	V_{CBO}	400	V	
Collector to emitter voltage	V_{CEO}	400	V	
Emitter to base voltage	V _{EBO}	5	V	
Peak collector current	I_{CP}	200	mA	
Collector current	I_{C}	100	mA	
Collector power dissipation	P_{C}^{*}	1	W	
Junction temperature	T _j	150	°C	
Storage temperature	T_{stg}	−55 ~ +150	°C	

 $^{^{*}}$ Printed circuit board: Copper foil area of $1 \mathrm{cm}^2$ or more, and the board thickness of 1.7mm for the collector portion



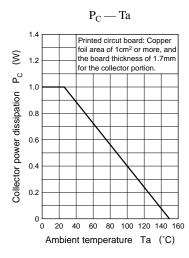
Marking symbol: 1S

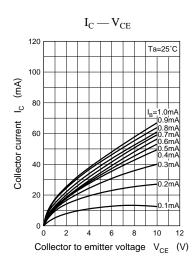
Electrical Characteristics (Ta=25°C)

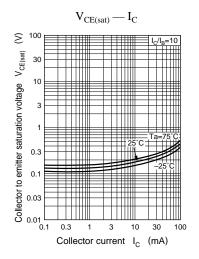
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V _{CBO}	$I_{\rm C} = 100 \mu A, I_{\rm E} = 0$	400			V
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = 500 \mu A, I_{\rm B} = 0$	400			V
Emitter to base voltage	V _{EBO}	$I_{\rm E} = 100 \mu A, I_{\rm C} = 0$	5			V
Forward current transfer ratio	h _{FE}	$V_{CE} = 5V$, $I_C = 30mA$	30			
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 50 \text{mA}, I_B = 5 \text{mA}$			1.5	V
Base to emitter saturation voltage	V _{BE(sat)}	$I_C = 50 \text{mA}, I_B = 5 \text{mA}$			1.5	V
Transition frequency	f_T	$V_{CB} = 30V, I_{E} = -20mA, f = 200MHz$		40		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 30V, I_E = 0, f = 1MHz$			7	pF

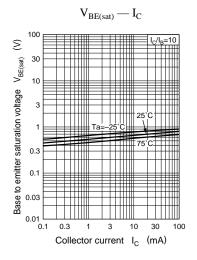
Panasonic 1

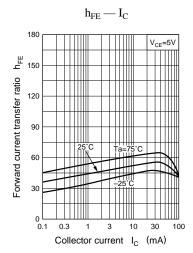
Transistor 2SD2413

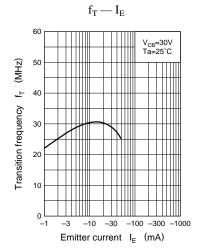


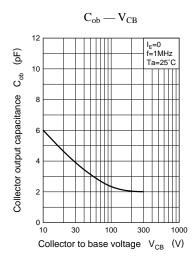












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